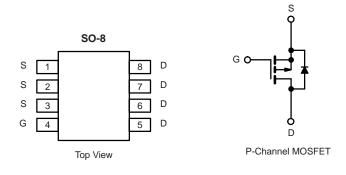


### P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
- 40	0.010 at $V_{GS}$ = - 10 V	- 16.1	33 nC			
- 40	0.014 at V <sub>GS</sub> = - 4.5 V	- 13.3	33110			



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- 100 % Rg Tested
- 100 % UIS Tested ٠
- Compliant to RoHS Directive 2002/95/EC ٠

#### **APPLICATIONS**

- Load Switch
- POL •

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage Gate-Source Voltage		V <sub>DS</sub>	- 40	V	
		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		- 16.1		
Continuous Drain Current (T. 150 °C)	T <sub>C</sub> = 70 °C	1 . Г	- 12.9		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 10.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 8.2 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	- 50	A	
	T <sub>C</sub> = 25 °C		- 5.3		
Continous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	- 28		
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	39	mJ	
	T <sub>C</sub> = 25 °C		6.3		
Maximum Rower Dissinction	T <sub>C</sub> = 70 °C		4	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C	1 -	1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
	Symbol	Typical	Maximum	Unit			
t ≤ 10 s	R <sub>thJA</sub>	37	50	°C/W			
Steady State	R <sub>thJF</sub>	16	20	- 0/11			
	t ≤ 10 s	$\begin{array}{c c} & \textbf{Symbol} \\ \hline t \leq 10 \text{ s} & R_{\text{thJA}} \end{array}$	SymbolTypical $t \le 10$ s $R_{thJA}$ 37	SymbolTypicalMaximum $t \le 10$ s $R_{thJA}$ 3750			

Notes:

a. Based on  $T_C = 25$  °C. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

服务热线:400-655-8788

# RoHS COMPLIANT

HALOGEN

FREE

### **AP9563M**

<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted									
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 40			V			
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 36		mV/°C			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η 200 μΑ		5					
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 1.2		- 2.5	V			
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA			
Zana Casta Malta na Drain Company		V <sub>DS</sub> = - 40 V, V <sub>GS</sub> = 0 V	= 0 V		- 1				
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 5	μA			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 5 V, $V_{GS}$ = - 10 V	- 25			A			
	D	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10.2 A		0.010		Ω			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 8.4 A		0.014					
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 10.2 A		37		S			
Dynamic <sup>b</sup>	I			<b></b>	•	1			
Input Capacitance	C <sub>iss</sub>			3007		pF			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		335					
Reverse Transfer Capacitance	C <sub>rss</sub>			291					
Total Gate Charge	Qg	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10.2 A		64	95	nC			
				33	50				
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 10.2 A		9.8					
Gate-Drain Charge	Q <sub>gd</sub>			15.7					
Gate Resistance	Rg	f = 1 MHz	0.4	2	4	Ω			
Turn-On Delay Time	t <sub>d(on)</sub>			57	86				
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, R <sub>L</sub> = 2.4 $\Omega$		50	75	ns			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 8.2 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		40	60				
Fall Time	t <sub>f</sub>			17	26				
Turn-On Delay Time	t <sub>d(on)</sub>			13	20				
Rise Time	t <sub>r</sub>	$V_{DD} = -20 \text{ V}, \text{ R}_{1} = 2.4 \Omega$		11	20				
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 8.2 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		45	68				
Fall Time	t <sub>f</sub>	-		9	18				
Drain-Source Body Diode Characteristi	Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 5.3				
Pulse Diode Forward Current	I <sub>SM</sub>				- 50	A			
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = -8.2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.2	V			
Body Diode Reverse Recovery Time	t <sub>rr</sub>			36	54	ns			
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 8.2 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		41	62	nC			
Reverse Recovery Fall Time	t <sub>a</sub>			20		ns			
Reverse Recovery Rise Time	t <sub>b</sub>			16					

Notes:

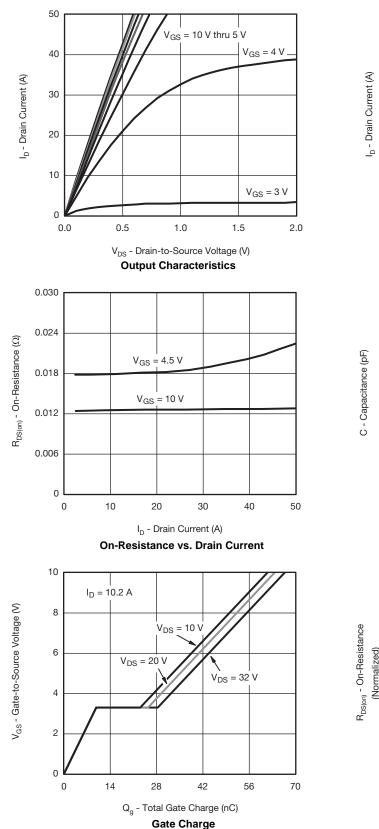
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

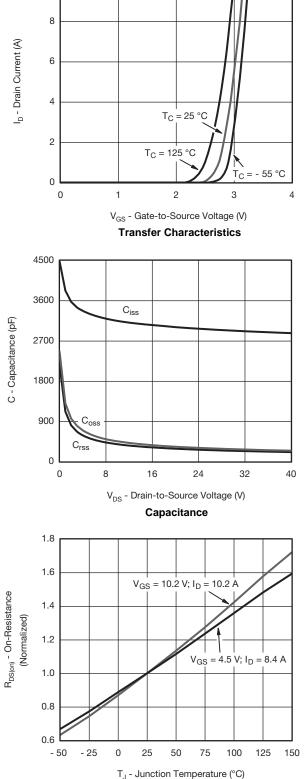
Bsemi

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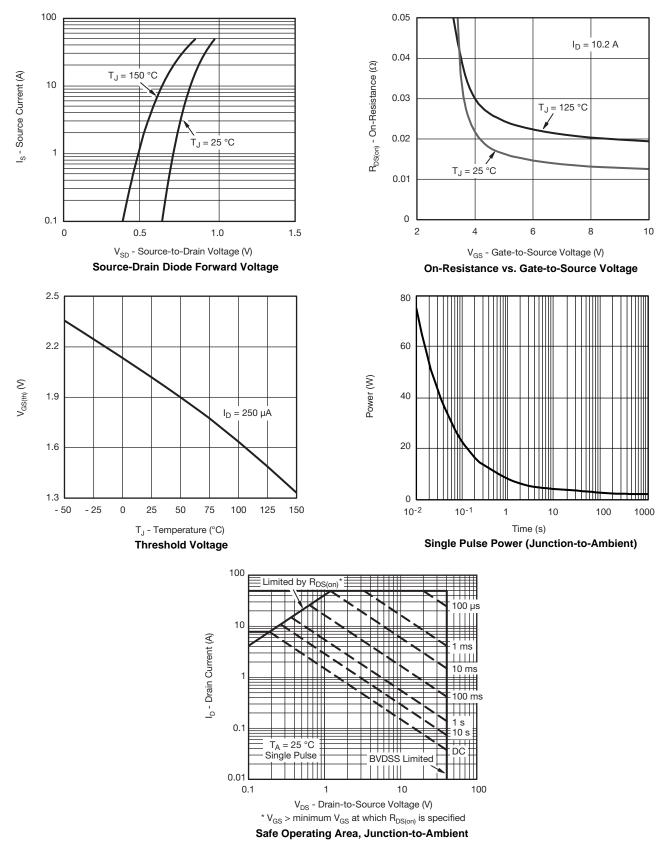
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



10

On-Resistance vs. Junction Temperature

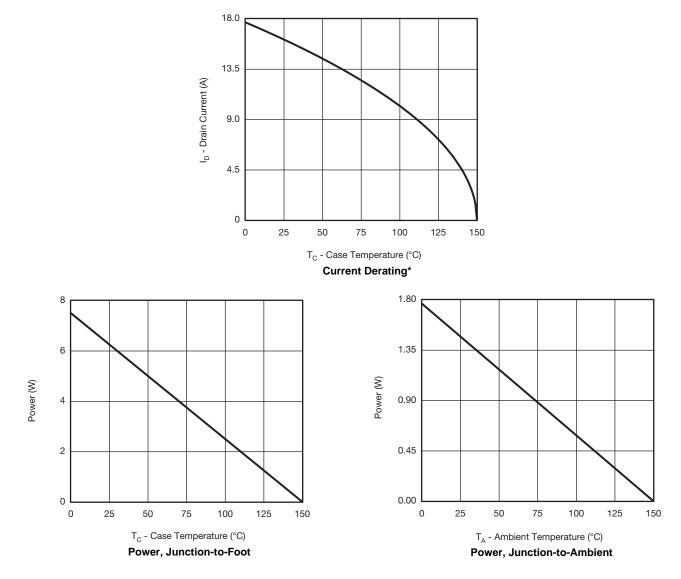




#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



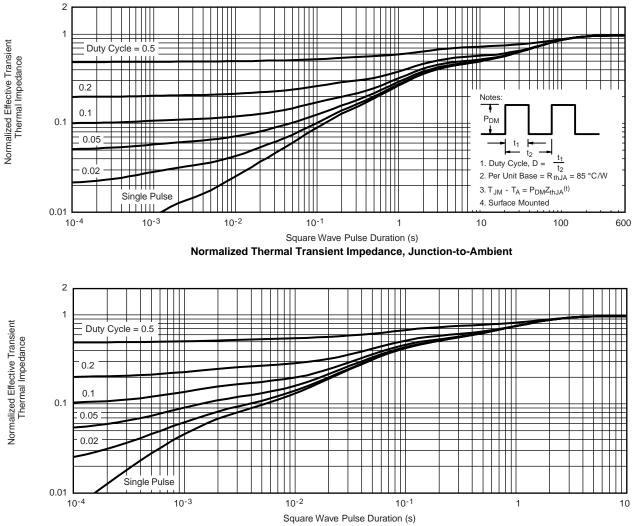
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





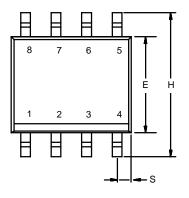


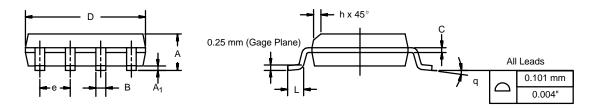
Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

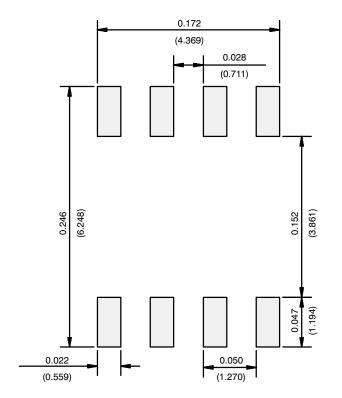




	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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